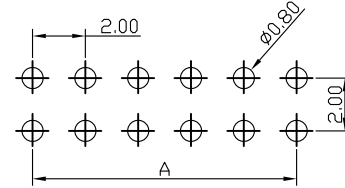
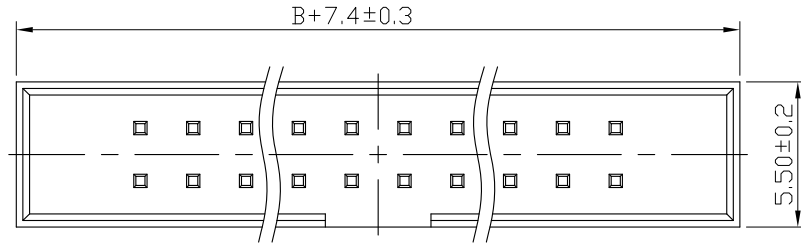


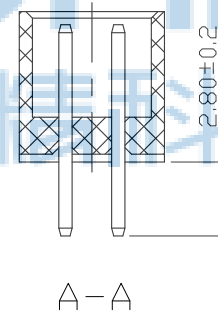
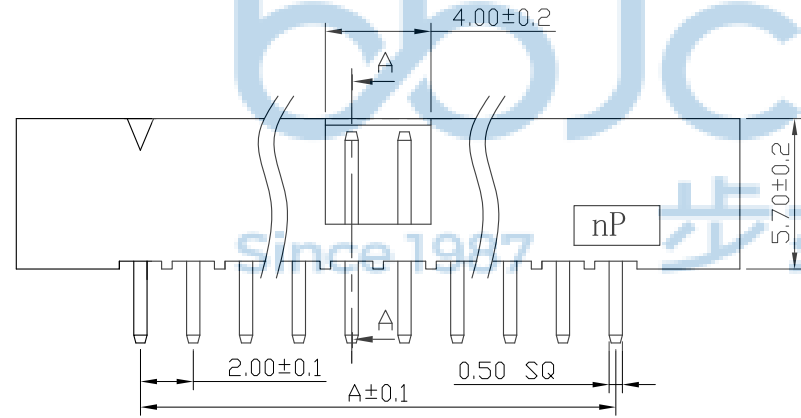
REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	SGF

SPECIFICATIONS

Current Rating: 1.5 Amps
 Insulation Resistance: 1000MΩ, Min
 Contact Resistance: 20mΩ, Max
 Withstanding Voltage: AC 500V
 Operation Temperature: -40° to+105°
 Contact Material: Brass
 Standard: PA6T
 Insrlator Material: Polyester (UL 94V-0)
 Contact Plating: Gold Flash
 Max.Processing Temp: 240° C for30-60seconds
 (260° C for5seconds)



RECOMMEND P. C. B LAYOUT
 PCB TOLERANCE: ± 0.05 (TOP VIEW)



No. of	DIM. A	DIM. B	No. of	DIM. A	DIM. B	No. of	DIM. A	DIM. B	No. of	DIM. A	DIM. B
6	4.00	6.00	24	22.00	24.00	42	40.00	42.00	60	58.00	60.00
8	6.00	8.00	26	24.00	26.00	44	42.00	44.00	62	60.00	62.00
10	8.00	10.00	28	26.00	28.00	46	44.00	46.00	64	62.00	64.00
12	10.00	12.00	30	28.00	30.00	48	46.00	48.00	66	64.00	66.00
14	12.00	14.00	32	30.00	32.00	50	48.00	50.00	68	66.00	68.00
16	14.00	16.00	34	32.00	34.00	52	50.00	52.00	70	68.00	70.00
18	16.00	18.00	36	34.00	36.00	54	52.00	54.00			
20	18.00	20.00	38	36.00	38.00	56	54.00	56.00			
22	20.00	22.00	40	38.00	40.00	58	56.00	58.00			

THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		深圳市步步精科技有限公司 .X: ± 0.38 .XX: ± 0.25 .XXX: ± 0.13 X': $\pm 3'$ X'': $\pm 2'$ XX': $\pm 1'$		NAME: 筒牛连接器 2.0DC3 60P (2x30) H5.7 180度 PC2.8 L8.0 6T 盒装 APPD. JM_Zheng CHKD. LYX DR. SGF		PJ. NO.: PH.08.12-96-3001 SIZE: A4 DRW NO.: FINISH: SEE NOTES MAT'L.: SEE NOTES SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/1	
PDWG.NO: 0266-1							